

RUHR-UNIVERSITÄT BOCHUM

On the Complexity Reduction of Laser Fault Injection Campaigns using OBIC Measurements

Falk Schellenberg, Markus Finkeldey, Bastian Richter, Maximilian Schäpers, Nils Gerhardt, Martin Hofmann and Christof Paar

Motivation

Fault injection into integrated circuits

- Clock glitches
- Voltage alterations
- EM
- Light (UV, flash lamps, **laser**)

Parameters for **successful** fault injection

- Timing (clock cycle and time within clock cycle)
- Length
- Physical intensity

Additional parameters for laser fault injection

- Focus (/spot size) (z)
- Location (x/y)
- **Doubled** for two-spot systems

➔ **Large search space, exhaustive search might be infeasible**

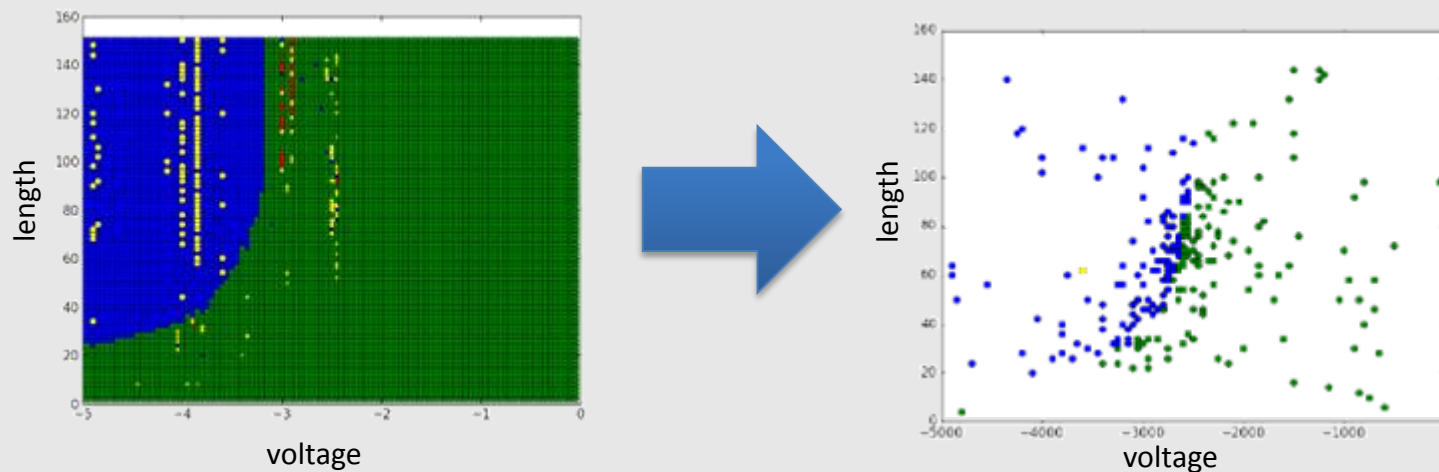
Reducing Search Space (1)

Carpi et al.: “Glitch It If You Can: Parameter Search Strategies for Successful Fault Injection”, CARDIS13

Picek et al.: “Evolving genetic algorithms for fault injection attacks”, MIPRO14

Picek et al.: “Fault Injection with a new Flavor: Memetic Algorithms make a difference”, COSADE15 (*)

Idea: Use machine learning for finding parameters



Hardly applicable to all parameters (timing, laser location)

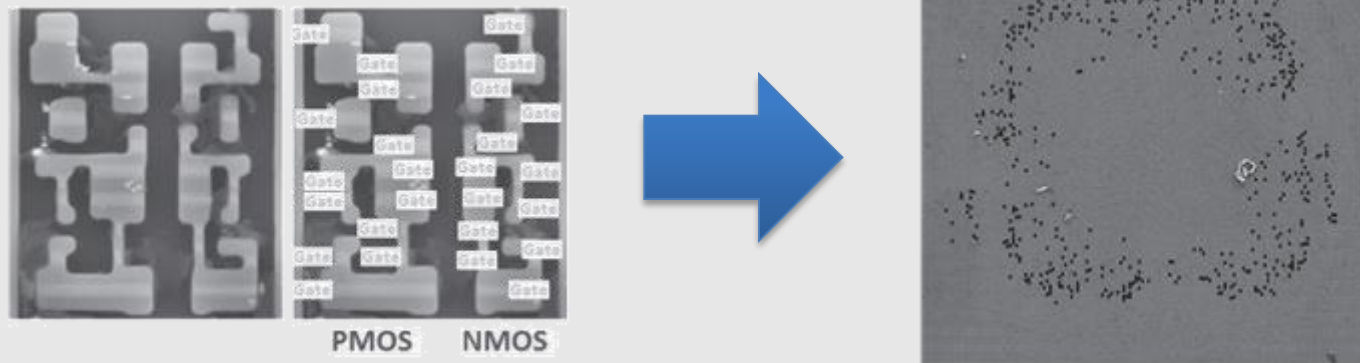
(*) Image Source

Reducing Search Space (2)

Franck Courbon et al.: “Increasing the efficiency of laser fault injections using fast gate level reverse engineering”, HOST14

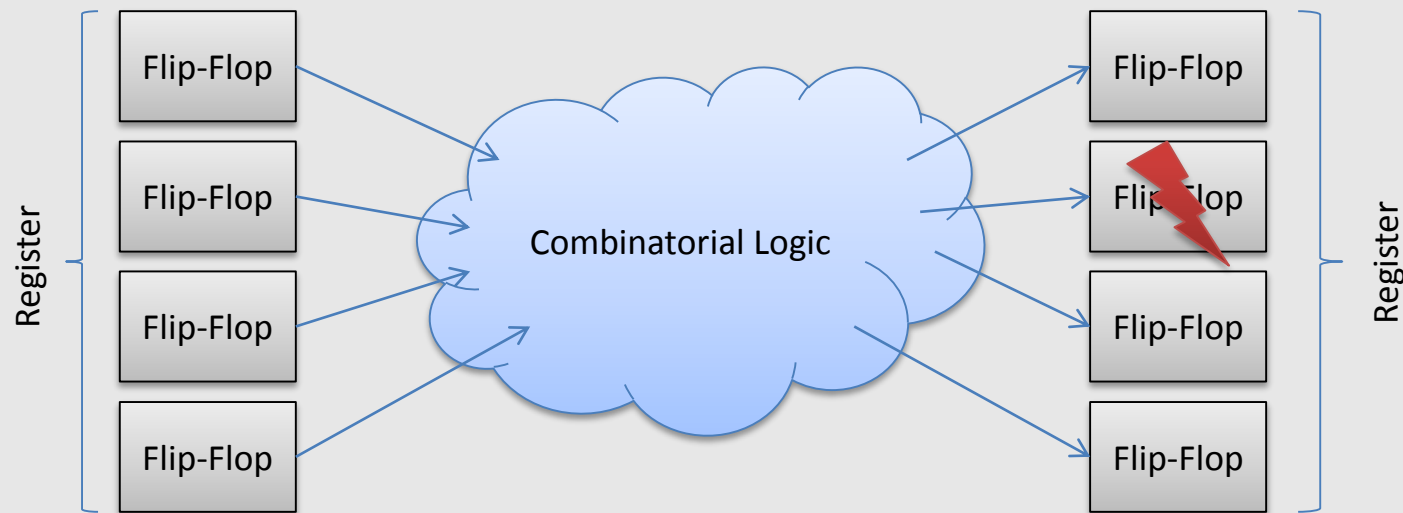
Idea:

1. Grind/polish down to doped area
2. Capture SEM images, identify **flip-flops**, find all other instances by correlation
3. Use locations for laser fault injection



Requires access to SEM, profiling sample gets destroyed

Importance of Flip-Flops



Fault has to be stored by a register, otherwise no effect

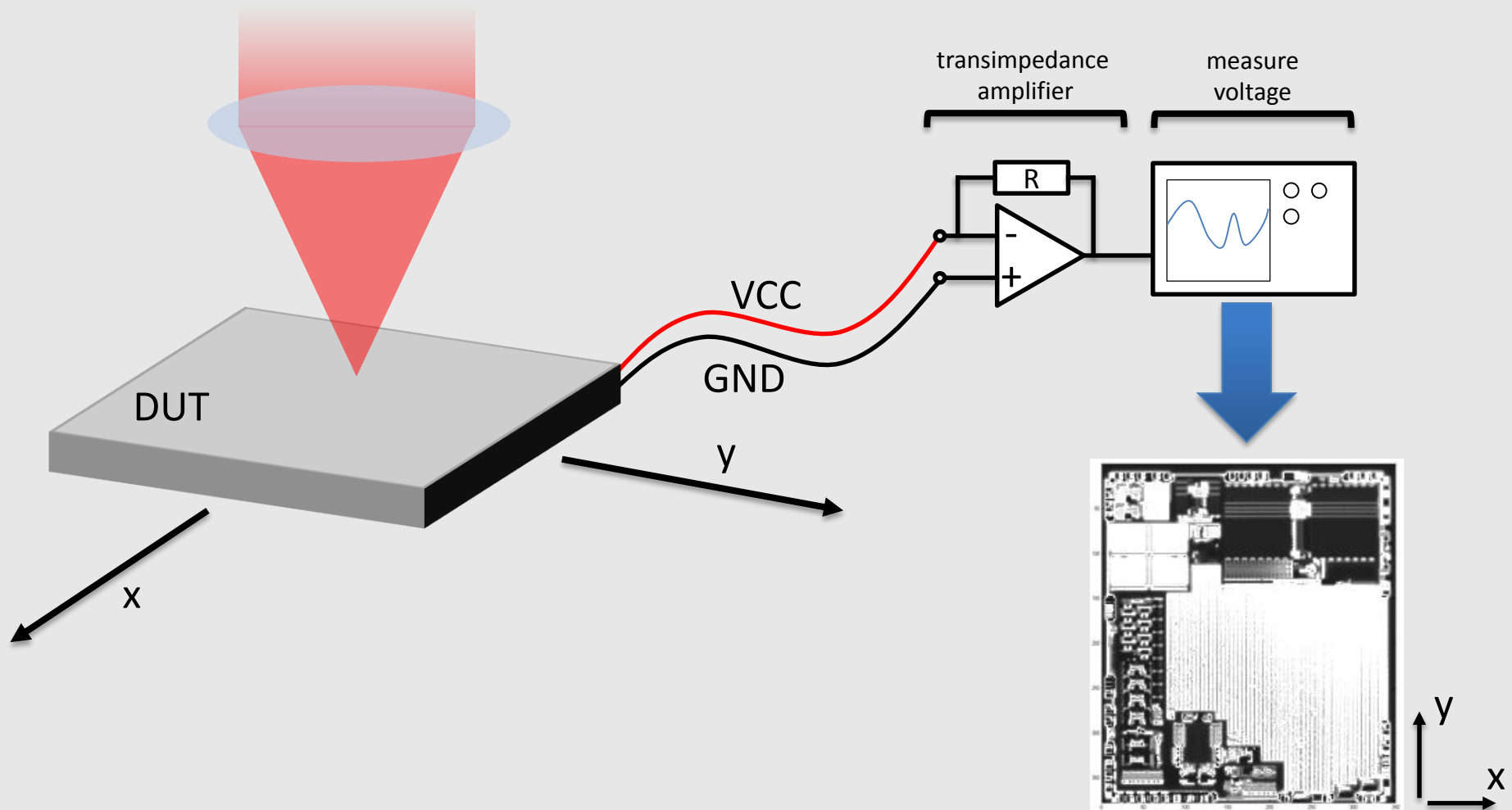
By directly targeting flip-flops

- Every possible single bit fault
- However, no multi bit faults

Optical Beam Induced Current

In a nutshell:

Use DUT as “really bad” photodiode → Measure current created at pn-junctions



Our Proposal

Optical Beam Induced Current (OBIC) as imaging technique

- High resolution
 - Identify locations (x,y,z)
 - Find flip-flops
- Reduces number of *Points of Interest* drastically

Advantages:

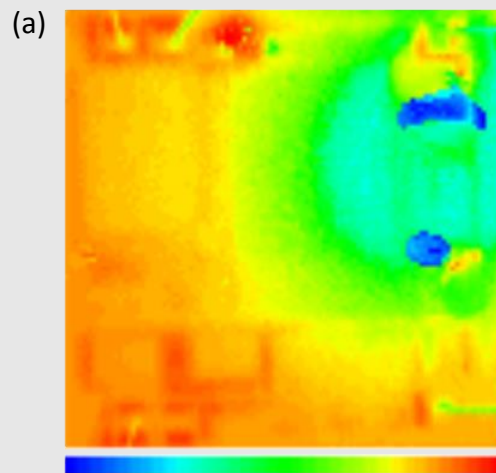
- Independent of other parameters (e.g., power, delay, length)
- Chip is not powered → no countermeasures can be active
- Minimal equipment overhead
- Possible with “every” laser setup

Disadvantage:

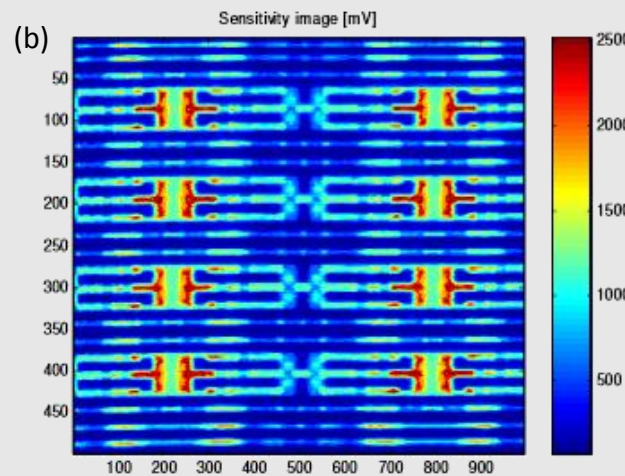
- Resolution not as powerful as SEM etc.

OBIC in Literature

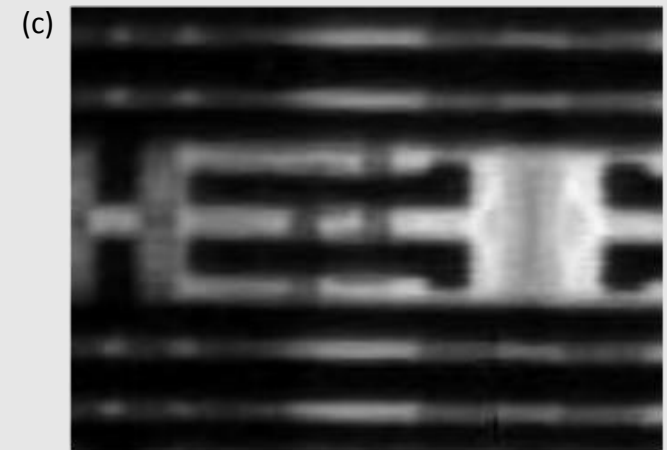
- Well-know in (production-) fault analysis
- Security context:



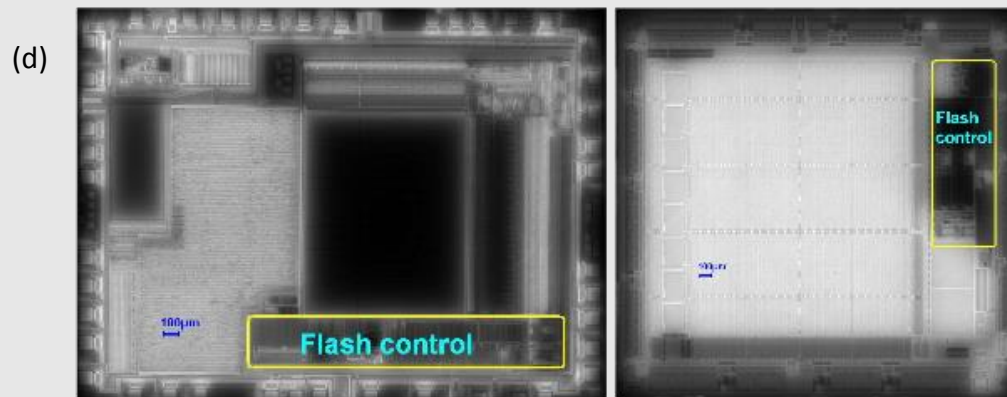
Unknown chip, backside!



Motorola μ C, SRAM, frontside



Microchip μ C, 0.9 μ m, SRAM, frontside



NEC μ C, 0.35 μ m, backside

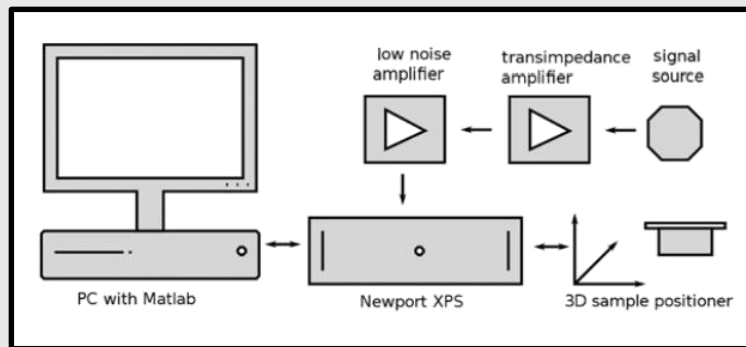
Actel FPGA, 0.13 μ m, backside

Image Sources:

- (a) van Woudenberg et al., Practical optical fault injection on secure microcontrollers, FDTC11
- (b) Skorobogatov, Semi-invasive attacks - A new approach to hardware security analysis, 2005
- (c) Skorobogatov, Optically enhanced position-locked power analysis, CHES06
- (d) Skorobogatov, Flash memory 'bumping' attacks, CHES 2010

Setup

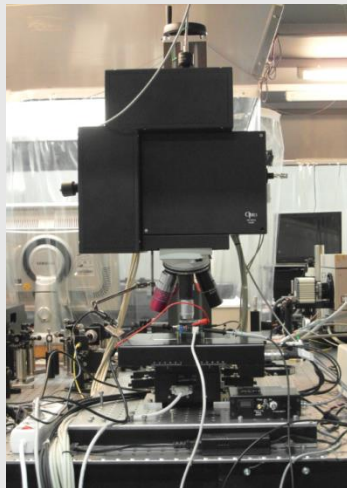
Measurement



Self-built setup

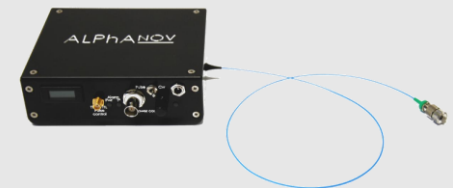
- Lumics laser diode at 1064nm, SMF
- Leica NIR objective (NA 0.75, 100x)
- Newport XPS with motorized stages
- FEMTO transimpedance amplifier connected to VDD/GND
- Stanford Research low noise amplifier

Fault Injection



Modified commercially available LFI setup

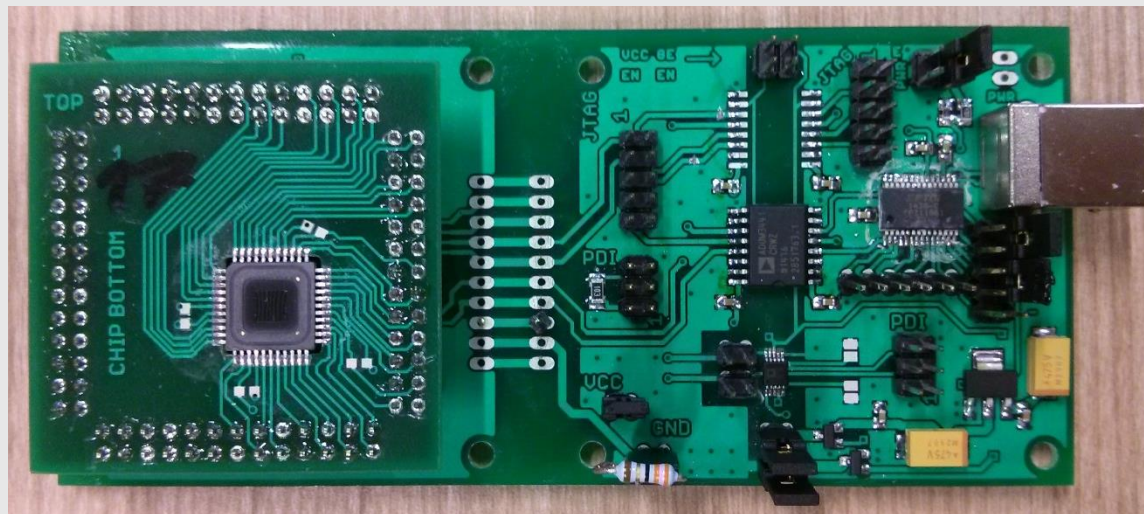
- Alphanov PDM 975nm 2W diode, SMF
- Mitutoyo Plan Apo NIR HR (NA 0.65, 50x)
- Märzhäuser and PI stages



Case Study: ATXMega16A4U

ATXMega16A4U, 250nm

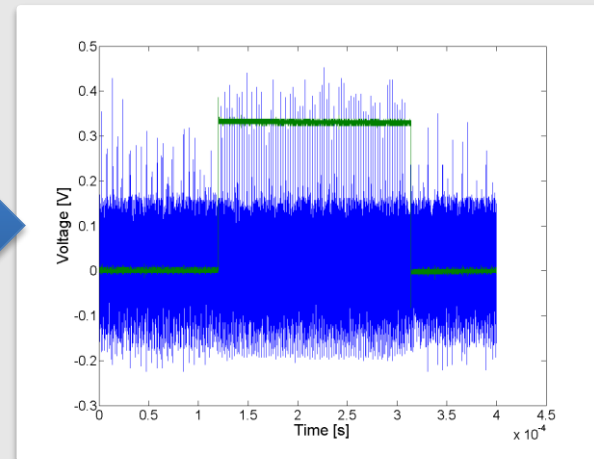
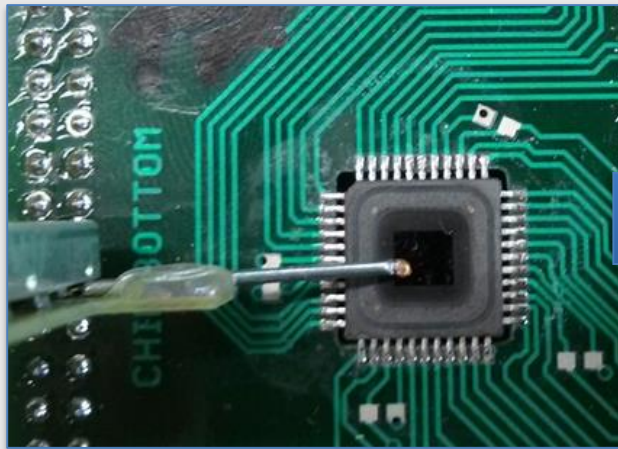
- Hardware Encryption
 - DES (“Round”-Instruction)
 - **AES** (Start/End-Flags)
- Backside thinned to approx. 20 μ m



Case Study: ATXMega16A4U

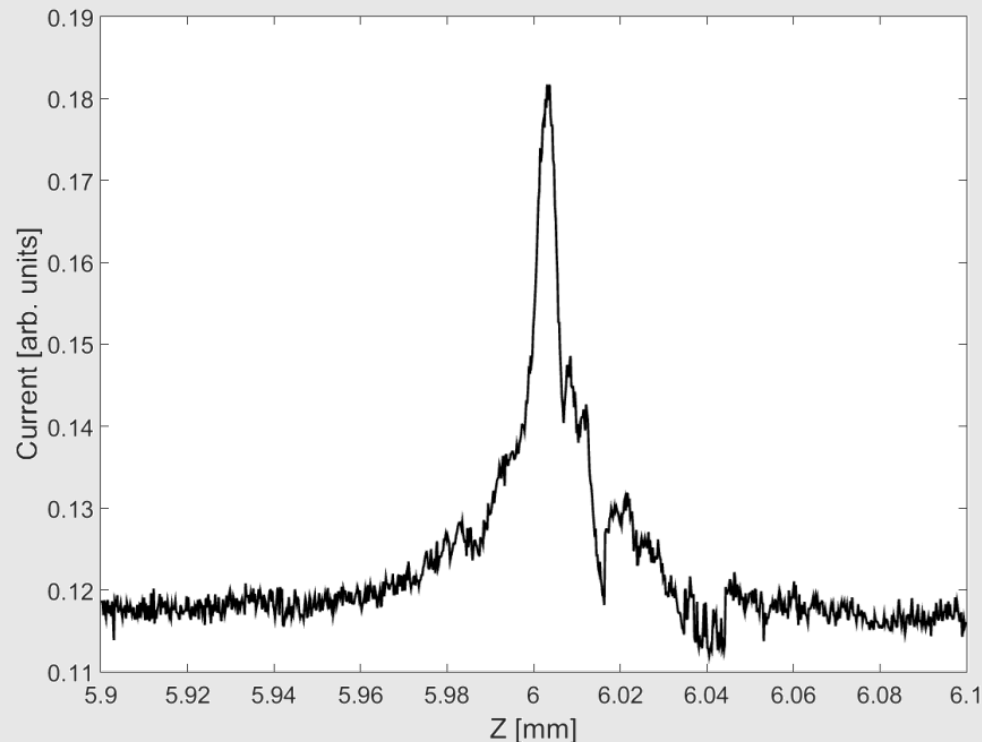
(1) Rough estimation by EM analysis (optional)

- Self-made probe with amplifier
- Trigger during encryption → clearly visible peaks



Case Study: ATXMega16A4U

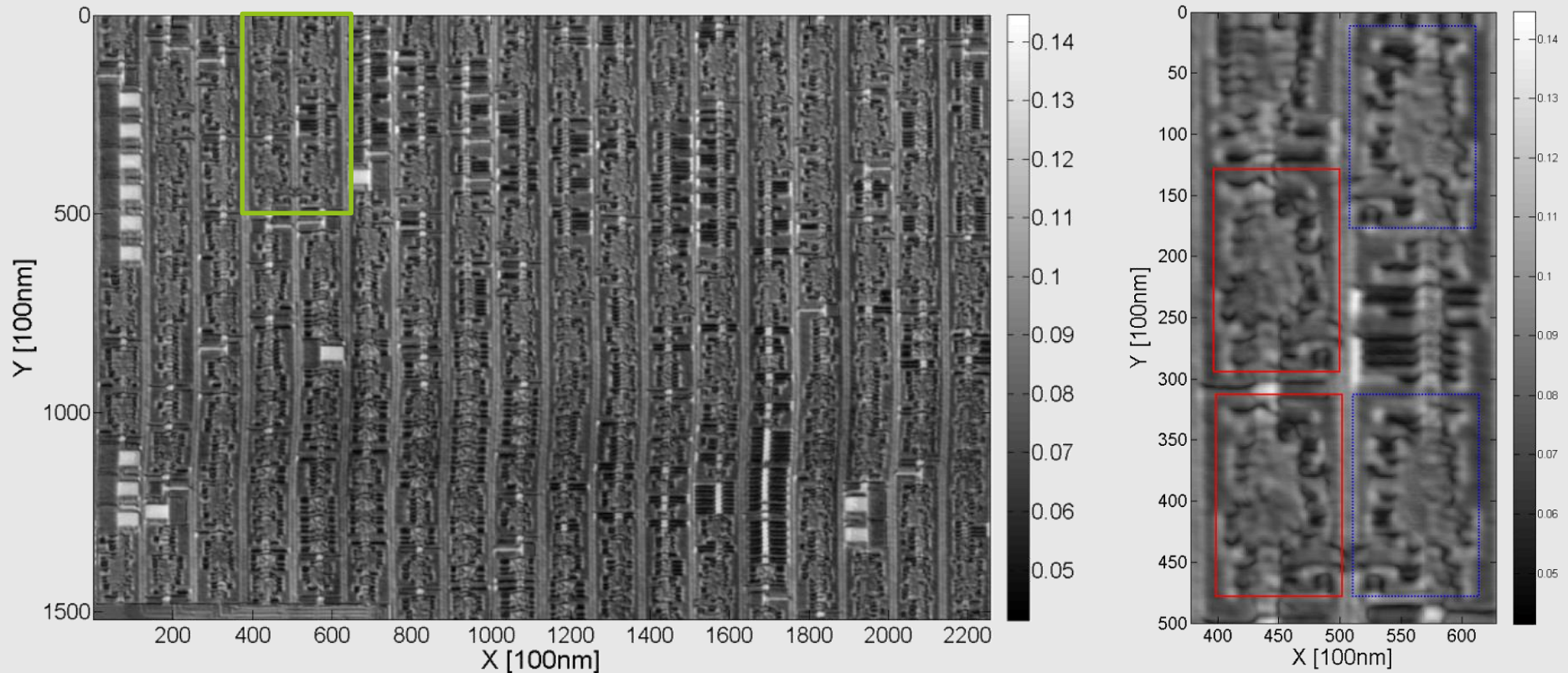
(2) OBIC Measurement around found area (z)



- Find focal plane resulting in maximum current
- → Optimal z-Position for OBIC and LFI
- Enables to account for tilted DUT with very high precision

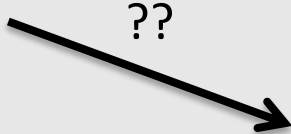
Case Study: ATX Mega16A4U

(2) OBIC Measurement around found area (x/y)



Case Study: ATX Mega16A4U

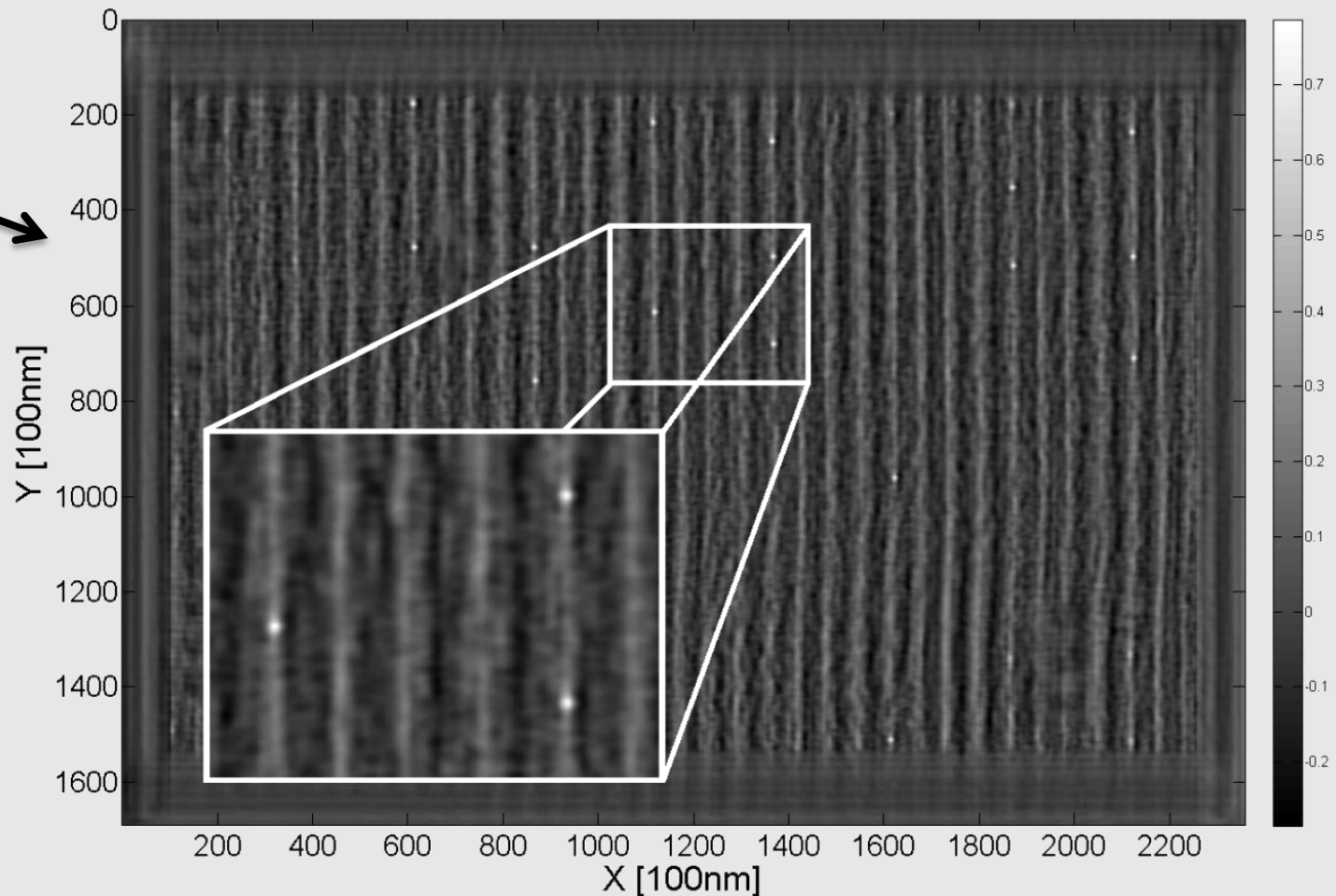
(3) Correlation-Based Pattern Recognition



Pearson correlation
0.6 up to ~0.8

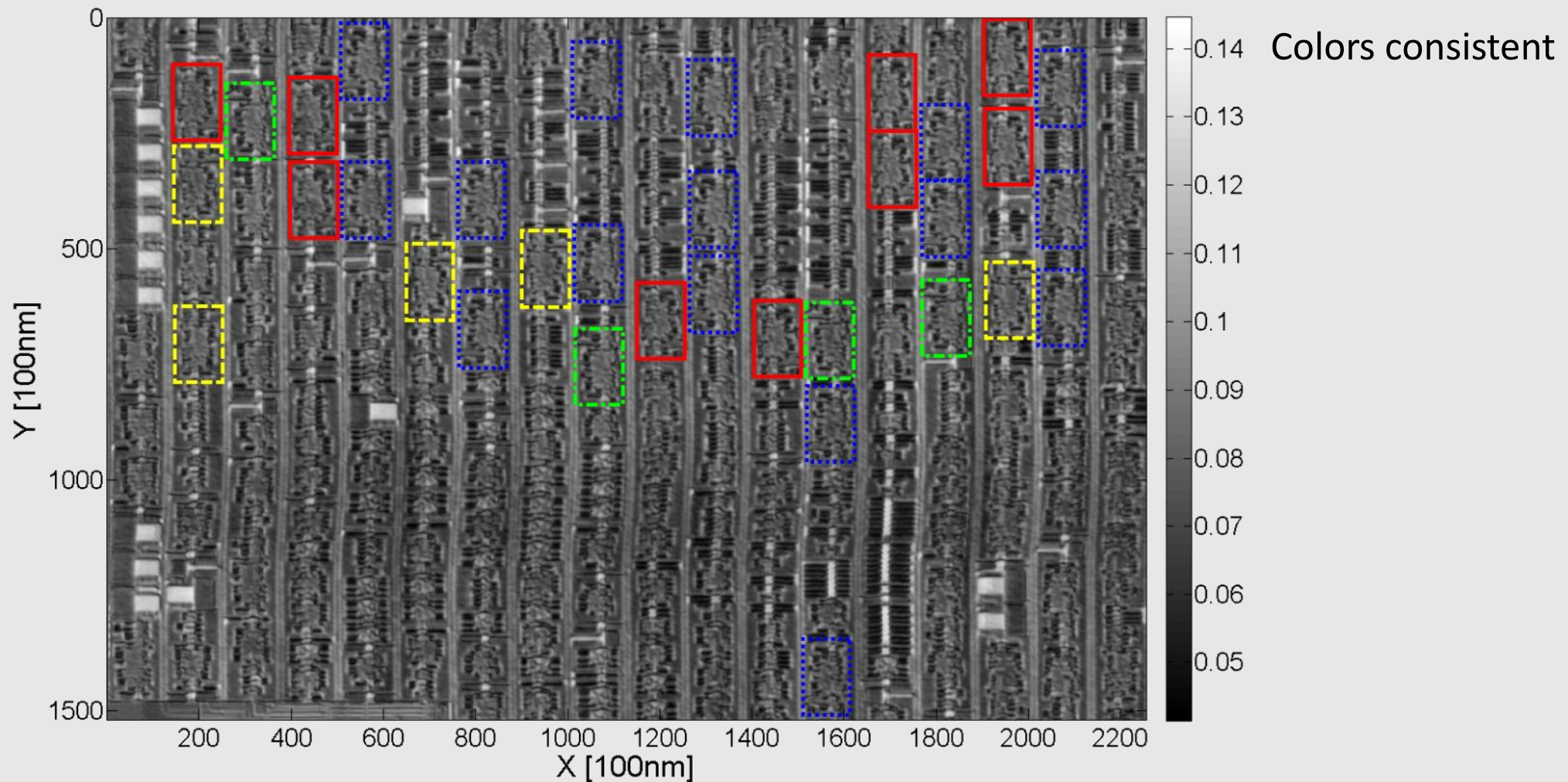
Four times for each
orientation

In a matter of
seconds



Case Study: ATX Mega16A4U

(3) Correlation-Based Pattern Recognition

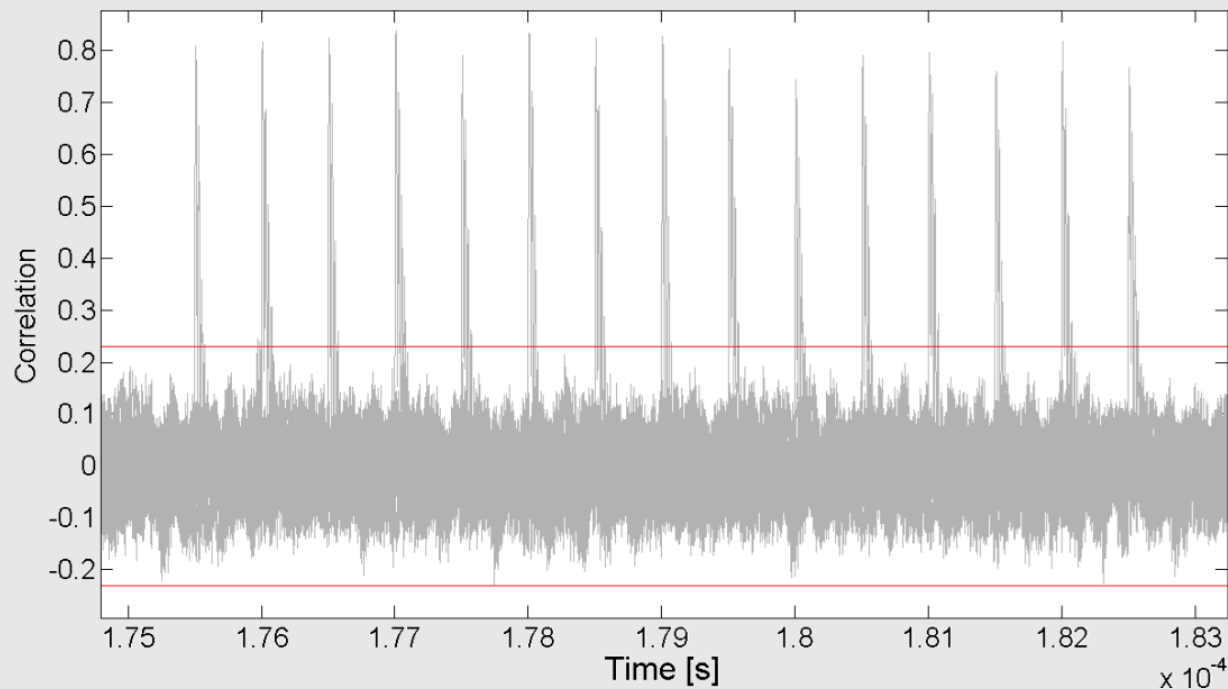


Case Study: ATX Mega16A4U

(4) Correct Timing (SHORTCUT)

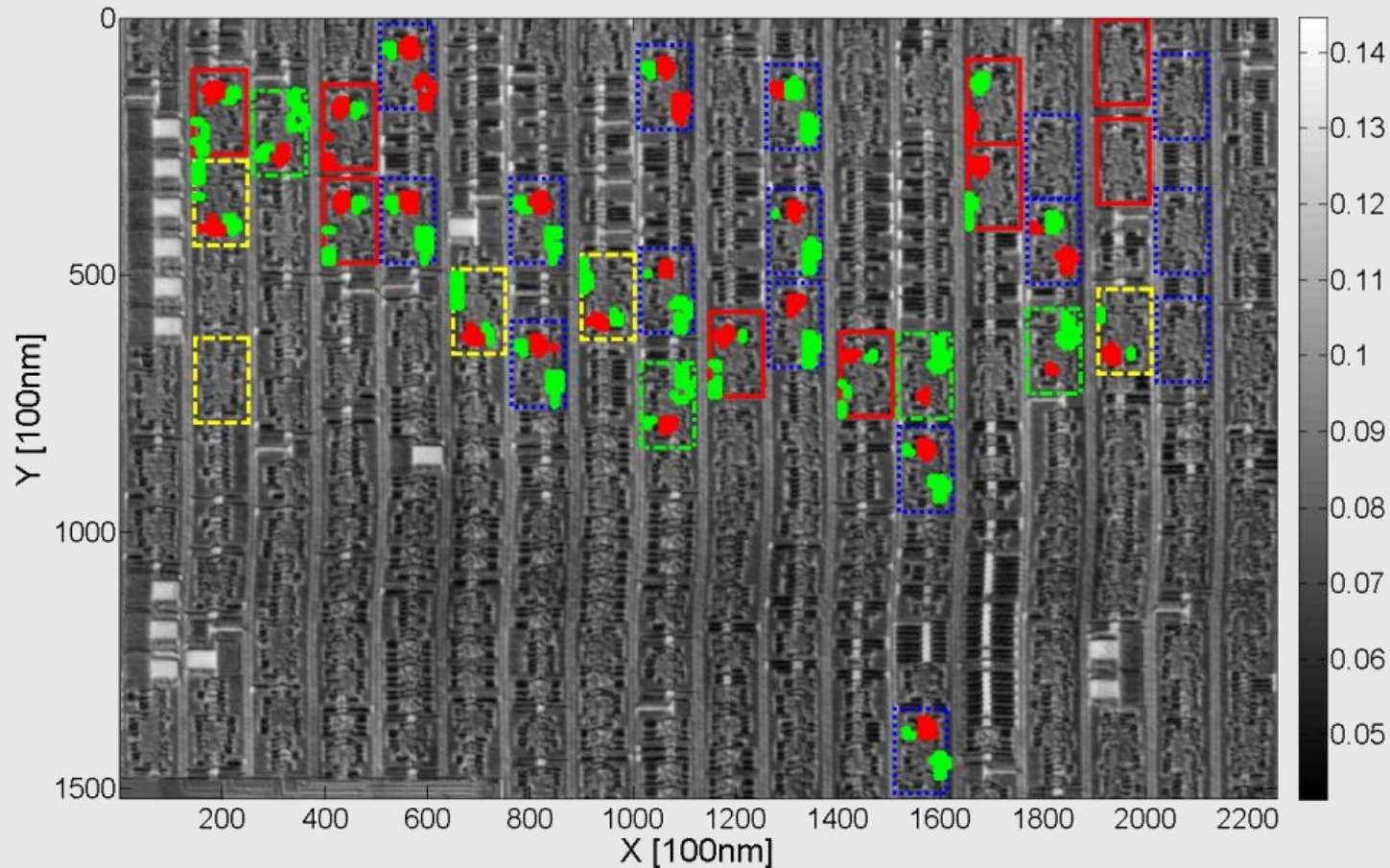
- Know-key correlation on intermediate values
- Example: Hamming Distance of state bytes s_i

$HD(s_i, s_{i+1})$ at input of last round



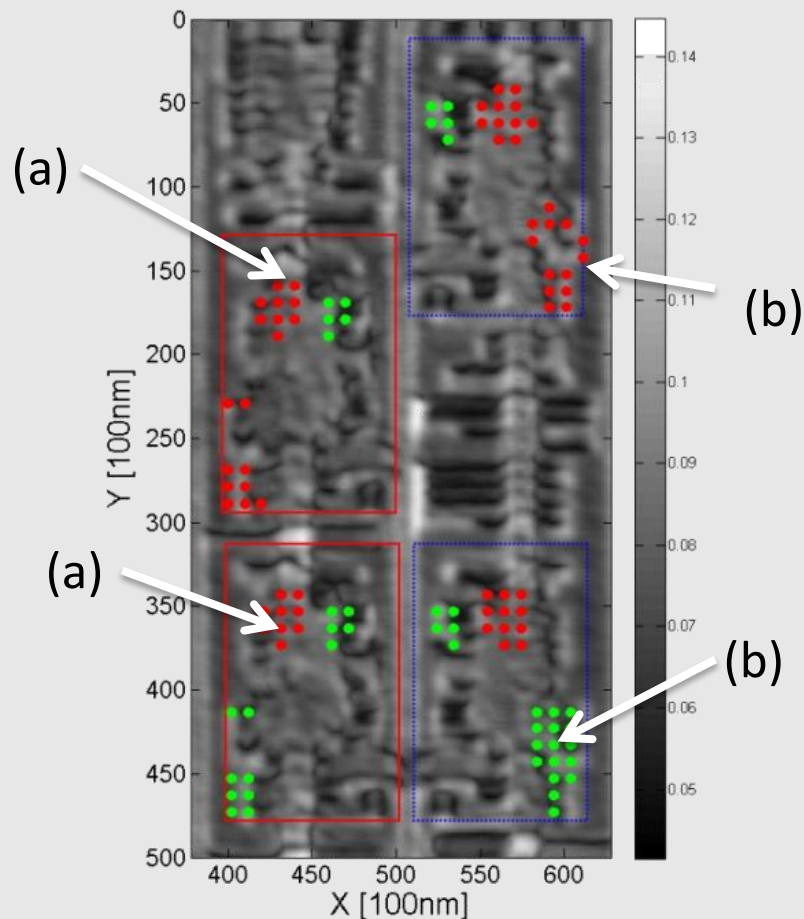
Case Study: ATX Mega16A4U

(5) Laser Fault Injection



Case Study: ATX Mega16A4U

(5) Laser Fault Injection - Detail



Calculated backwards based on known key
 Green: Bit Set
 Red: Bit Reset

(a) Complementary fault pattern consistent
 → Storage part?

(b) Changing third sensitivity zone
 → Clock input?
 → Reset?

Pattern identical when clock halted during LFI
 → Confirms flip-flop identification

Case Study: ATXMega16A4U

(6) Differential Fault Analysis

Straight-forward approach worked quite well:

1. Fault between MixColumns (9th round) and SubBytes (10th round) → **single byte faults at output**
2. Test for which key hypothesis the difference between faulty ciphertext and genuine ciphertext byte resolves to **single bit fault before SBox**

→ approx. two pairs ciphertext/faultytext per byte

Discussion (1)

Time Improvement

- Required time linearly depends on positions to test
- At $1\mu\text{m}$ steps for given area and 34 found flip-flops:
 - $255 * 150 = \mathbf{38250}$ points exhaustive search
 - $34 * 17 * 10 = \mathbf{5780}$ only flip-flop area
- Targeting only sensitive areas: $3 * 34 = \mathbf{102}$

Discussion (2)

Applicability

Influencing parameters

- Technology node (ATXMega16A4U: 250nm)
- Characteristic cell layout (ATXMega16A4U: $17\mu\text{m} \times 10\mu\text{m}$ area)
- *Effective* spot size (our setup: approx. 710nm calculated spatial resolution)

→ ATXMega16A4U: plenty of structural detail for given resolution

Smaller technology nodes:

- Averaging, fine-adjusting laser energy, 2-photon absorption, solid immersion lenses
- Potentially hard to *manually* identify flip-flops
- Autocorrelation?
- Future work..

Conclusion

- Used OBIC measurement as profiling to find flip-flops
 - Device shut off (no reactive countermeasures)
 - Independent of correct timing, pulse length (, energy)
- Reduced search space by factor of 6.6 or 375
- Successfully attacked ATXMega16A4U AES core

Countermeasures:

- Isolated power supply (probe bulk directly?)

The logo consists of a large green '50' with the word 'Jahre' in a smaller green font to its right, all set against a white background.The logo features the letters 'RUB' in a bold, white, sans-serif font, centered within a dark blue rectangular box.The text 'RUHR-UNIVERSITÄT BOCHUM' is written in a dark blue, sans-serif font.The text 'Thanks!' and 'Questions?' is displayed in a large, bold, dark blue, sans-serif font, with 'Thanks!' on the top line and 'Questions?' on the bottom line.